

SOD-123FL Plastic-Encapsulate Diodes

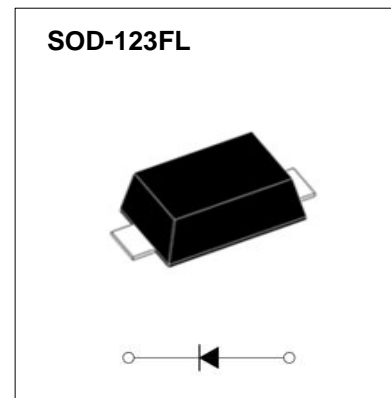
General Purpose Rectifier

Features

- I_o 1A
- VRRM 50V-1000V
- Low forward voltage drop
- High surge current capability
- Glass passivated chip junction

Mechanical Data

- Case: SOD-123FL molded plastic
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL-STD-202, Method 208
- Polarity: Color band denotes cathode end



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	DSR1						
				A	B	D	G	J	K	M
Repetitive Peak Reverse Voltage	V_{RRM}	V		50	100	200	400	600	800	1000
Maximum RMS Voltage	V_{RMS}	V		35	70	140	280	420	560	700
Maximum DC Blocking Voltage	V_{DC}	V		50	100	200	400	600	800	1000
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, $T_L=120^{\circ}C$	1						
Surge(Non-repetitive)Forward Current	I_{FSM}	A	60Hz Half-sine wave, 1 cycle, $T_a=25^{\circ}C$	30						
Junction Temperature	T_J	$^{\circ}C$		-55~+150						
Storage Temperature	T_{STG}	$^{\circ}C$		-55 ~ +150						

Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition	Max	
Peak Forward Voltage	V_{FM}	V	$I_{FM}=1.0A$	1.0	
Peak Reverse Current	I_{RRM1}	μA	$V_{RM}=V_{RRM}$	$T_a=25^{\circ}C$	5
	I_{RRM2}			$T_a=125^{\circ}C$	50
Reverse Recovery Time (Typical)	T_{rr}	us	$I_F=0.5A$ $I_R=1A$ $I_{RR}=0.25A$	1.8	
Junction Capacitance (Typical)	C_j	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C.	7	
Thermal Resistance (Typical)	$R_{\theta JA}$	$^{\circ}C/W$	Between junction and ambient	85	
	$R_{\theta JL}$		Between junction and lead	23	
	$R_{\theta JC}$		Between junction and case	15	

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

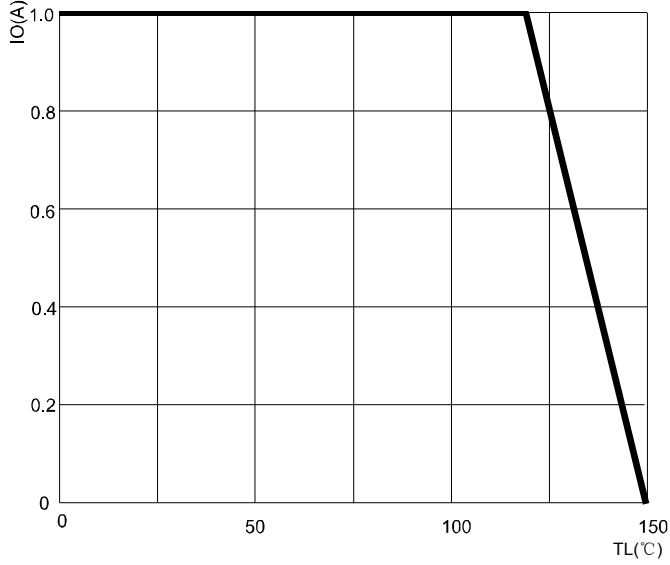


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

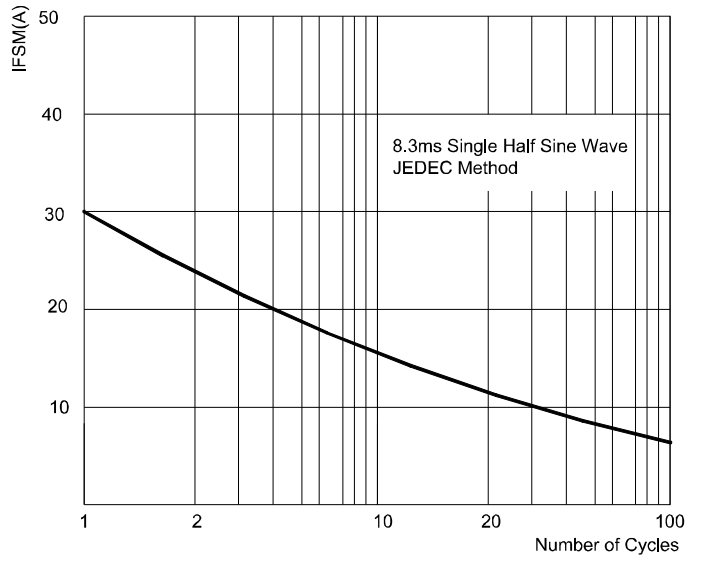


FIG.3: TYPICAL FORWARD CHARACTERISTICS

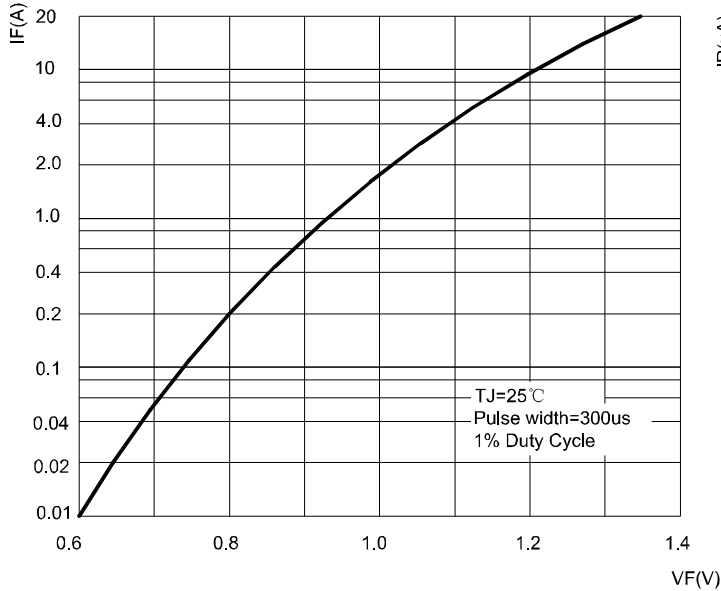
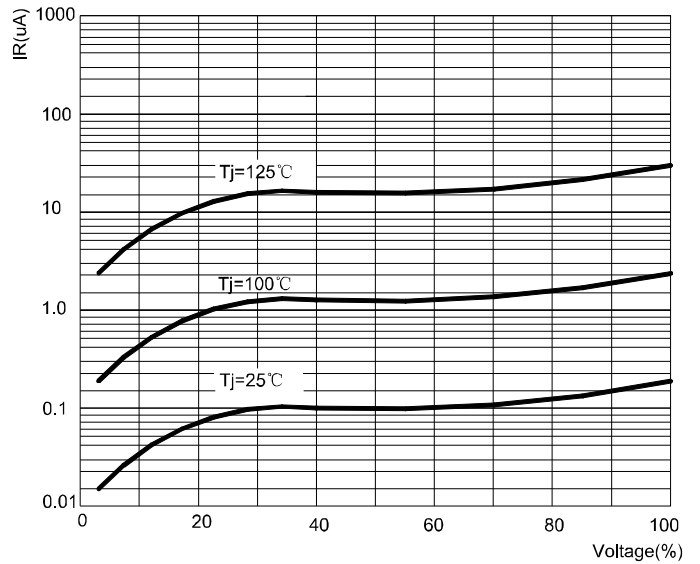
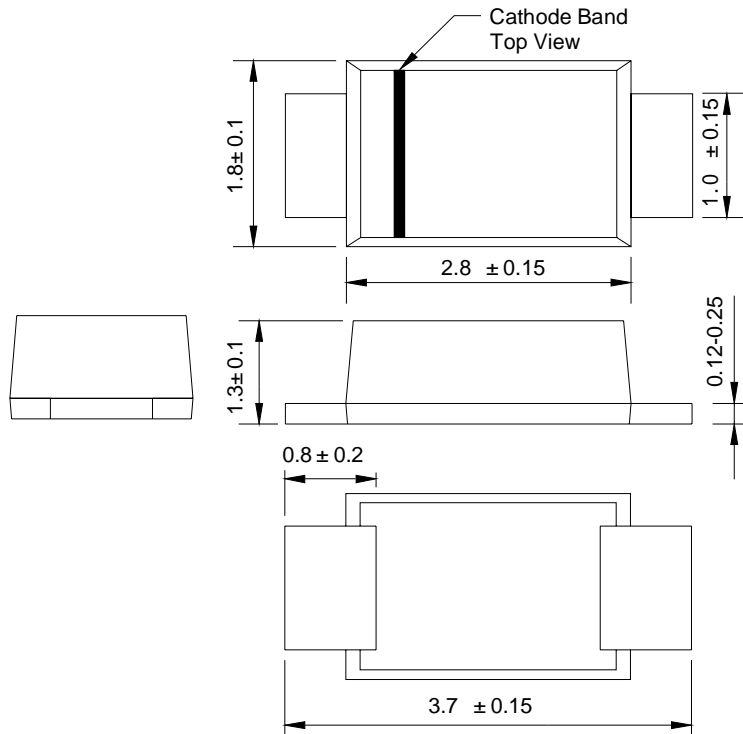


FIG.4: TYPICAL REVERSE CHARACTERISTICS

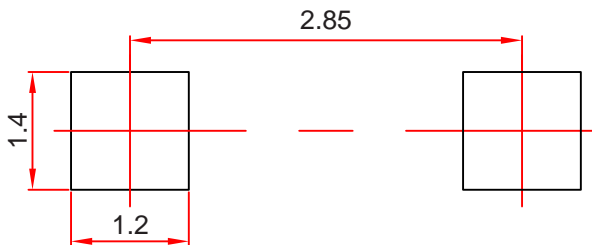


SOD-123FL Package Outline Dimensions



Dimensions in millimeters

SOD-123FL Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

Ordering Information

Part Number	Package	Shipping Quantity
DSR1A-DSR1M	SOD-123FL	3000/tape&Reel

Marking Diagram



X: From 1 To 7

Reel Taping Specifications For Surface Mount Devices–SOD-123FL

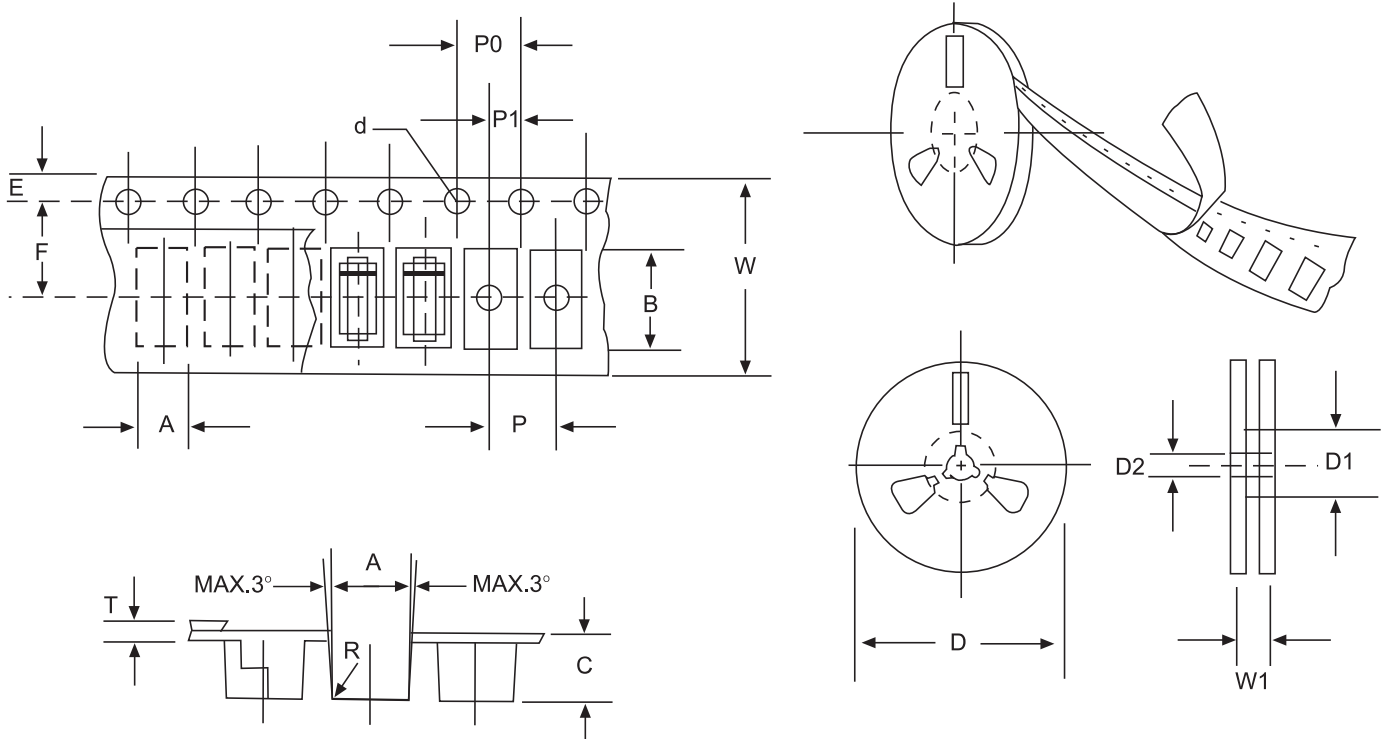


FIG : CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Stroket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Totall tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.